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PATENT JAV/4

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Chin et al.

Confirmation Number: 8566

Serial No.: 09/310,256

Group Art Unit: 1765

Filed: May 12, 1999

For:

Examiner: Ahmed, S.

TKHR Docket No. 252016-2270 Top-Team Ref. 0503-A30690US

LEVEL FOR DRY ETCH

TSMC Ref. TSMC98-574

Certificate of Mailing

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to: Mail Stop A mendment; Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on November 22, 2004/

METHOD TO REDUCE PARTICLE

Signature – Hui Chin Barnhill

AMENDMENT AND RESPONSE TO NOTICE OF NON-COMPLIANCE

Mail Stop - Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

This is in response to a Note of Non-Compliance of 07/24/03. Please consider the

following:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this

paper.

Remarks/Arguments begin on page 10 of this paper.